

THYRISTOR MODULE

AK90GB40/80

TOP



UL;E76102 (M)

Power ThyristorModule AK90GB series are designed for various rectifier circuits and power controls. For your circuit application. following internal connections and wide voltage ratings up to 800V are available, and electrically isolated mounting base make your mechanical design easy.

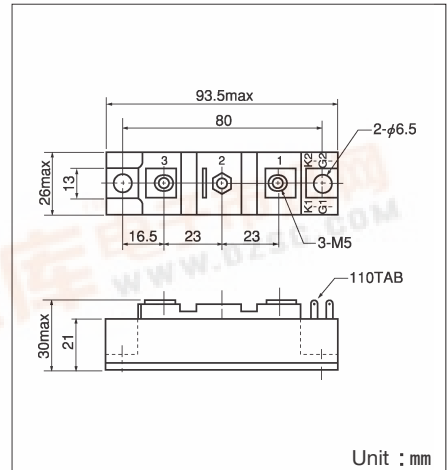
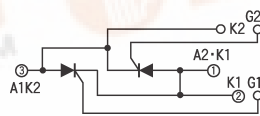
Isolated mounting base

- $I_T(AV)$ 90A, $I_T(RMS)$ 200A, I_{TSM} 1800A
- di/dt 200 A/ μs
- dv/dt 500V/ μs

(Applications)

- AC/DC motor drives
- Heater controls
- Light dimmers
- Static switches

Internal Configurations



Maximum Ratings

($T_j=25^\circ C$ unless otherwise specified)

Symbol	Item	Ratings		Unit
		AK90GB40	AK90GB80	
V _{DRM}	Repetitive Peak Off-State Voltage	400	800	V

Symbol	Item	Conditions	Ratings	Unit	
$I_T(AV)$	Average On-State Current	Single phase, half wave, 180° conduction, $T_c : 91^\circ C$	90	A	
$I_T(RMS)$	R.M.S. On-State Current	$T_c : 91^\circ C$	200	A	
I_{TSM}	Surge On-State Current	1/2 cycle, 50Hz/60Hz, peak value, non-repetitive	1650/1800	A	
I^2t	I^2t	Value for one cycle of surge current	15000	A ² S	
P _{GM}	Peak Gate Power Dissipation		10	W	
P _{G(AV)}	Average Gate Power Dissipation		3	W	
I _{FGM}	Peak Gate Current		3	A	
V _{FGM}	Peak Gate Voltage (Forward)		10	V	
V _{VRGM}	Peak Gate Voltage (Reverse)		5	V	
di/dt	Critical Rate of Rise of On-State Current	$I_G=100mA, T_j=25^\circ C, V_D=1/2 V_{DRM}, di/dt=0.1A/\mu s$	200	A/ μs	
V _{ISO}	Isolation Breakdown Voltage (R.M.S.)	A.C. 1 minute	2500	V	
T _j	Operating Junction Temperature		-40~+125	°C	
T _{stg}	Storage Temperature		-40~+125	°C	
	Mounting Torque	Mounting (M6)	Recommended Value 2.5~3.9 (25~40)	4.7 (48)	N·m (kgf·cm)
		Terminal (M5)	Recommended Value 1.5~2.5 (15~25)	2.7 (28)	
	Mass	Typical Value		170	g

Electrical Characteristics

Symbol	Item	Conditions	Ratings	Unit
I _{DRM}	Repetitive Peak Off-State Current, max.	at V _{DRM} , Single phase, half wave, $T_j=125^\circ C$	30	mA
V _{TM}	Peak On-State Voltage, max.	On-State Current 270A, $T_j=125^\circ C$ Inst. measurement	1.30	V
I _{GT} /V _{GT}	Gate Trigger Current/Voltage, max.	$T_j=25^\circ C, I_T=1A, V_D=6V$	100/3	mA/V
V _{GD}	Non-Trigger Gate, Voltage. min.	$T_j=125^\circ C, V_D=1/2 V_{DRM}$	0.25	V
t _{gt}	Turn On Time, max.	$I_T=90A, I_G=100mA, T_j=25^\circ C, V_D=1/2 V_{DRM}, di/dt=0.1A/\mu s$	10	μs
dv/dt	Critical Rate of Rise of Off-State Voltage, min.	$T_j=125^\circ C, V_D=2/3 V_{DRM}$, Exponential wave.	500	V/ μs
I _H	Holding Current, typ.	$T_j=25^\circ C$	50	mA
I _L	Latching Current, typ.	$T_j=25^\circ C$	100	mA
R _{th(j-c)}	Thermal Impedance, max.	Junction to case, per 1/2 Module	0.30	°C/W
		Junction to case, per 1 Module	0.15	



